

N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE4606A uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

N-Channel

 $V_{DS} = 30V, I_{D} = 6.5A$

 $R_{DS(ON)}$ < 24m Ω @ V_{GS} =10V

 $R_{DS(ON)}$ < 37m Ω @ V_{GS} =4.5V

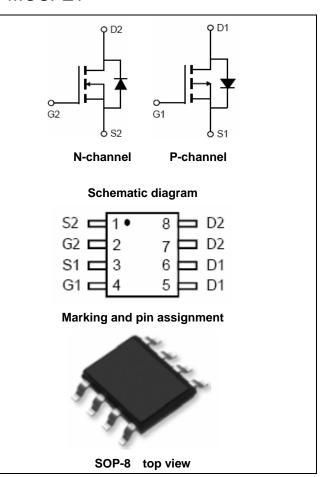
P-Channel

 $V_{DS} = -30V, I_D = -7A$

 $R_{DS(ON)}$ < 30m Ω @ V_{GS} =-10V

 $R_{DS(ON)}$ < 50m Ω @ V_{GS} =-4.5V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE4606A	NCE4606A	SOP-8	Ø330mm	12mm	4000 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage		V _{DS}	30	-30	V	
Gate-Source Voltage		V _{GS}	±20	±20	V	
Continuous Drain Current	T _A =25℃	- I _D	6.5	-7	^	
	T _A =70°C		5.4	-5.8	Α	
Pulsed Drain Current (Note 1)		I _{DM}	30	-30	А	
Maximum Power Dissipation T _A =25 ℃		P _D	2.0	2.0	W	
Operating Junction and Storage Temperature Range		T_{J} , T_{STG}	-55 To 150	-55 To 150	$^{\circ}$	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note2)	R _{0JA}	N-Ch	62.5	°C/W
Thermal Resistance, Junction-to-Ambient (Note2)	$R_{\theta JA}$	P-Ch	62.5	°C/W



N-CH Electrical Characteristics (T_A=25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)			•	•		•
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1	1.6	3	V
Drain Course On State Besistance		V _{GS} =10V, I _D =6A	-	19	24	- mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =6A	-	26	37	
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A	15	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V _{DS} =15V,V _{GS} =0V,	-	530.3	-	PF
Output Capacitance	Coss		-	67.1	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	61.2	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	4.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =2.5 Ω	-	2.5	-	nS
Turn-Off Delay Time	$t_{d(off)}$	V_{GS} =10 V , R_{GEN} =3 Ω	-	14.5	-	nS
Turn-Off Fall Time	t _f		-	3.5	-	nS
Total Gate Charge	Qg	V _{DS} =15V,I _D =6A,	-	14.2	-	nC
Gate-Source Charge	Q _{gs}		-	1.8	-	nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	3.3	-	nC
Drain-Source Diode Characteristics	·		•			
Diode Forward Voltage (Note 3)	V_{SD}	V _{GS} =0V,I _S =6A	-	0.8	1.2	V



P-CH Electrical Characteristics (T_A=25 [°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u>.</u>			•		•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-30	-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•			•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.0	-1.3	-2.0	V
Drain-Source On-State Resistance	Б	V _{GS} =-10V, I _D =-6.5A	-	24	30	mΩ
	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-5A	-	34	50	
Forward Transconductance	g FS	V_{DS} =-5 V , I_{D} =-6.5 A	10	-	-	S
Dynamic Characteristics (Note4)			•			•
Input Capacitance	C _{lss}	V _{DS} =-15V,V _{GS} =0V,	-	956.1	-	PF
Output Capacitance	C _{oss}		-	122	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	116.2	-	PF
Switching Characteristics (Note 4)				l.		Į.
Turn-on Delay Time	t _{d(on)}		-	8	-	nS
Turn-on Rise Time	t _r	V_{DD} =-15V, R_L =2.3 Ω	-	6	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =6 Ω	-	20	-	nS
Turn-Off Fall Time	t _f		-	7.5	-	nS
Total Gate Charge	Q_g	V _{DS} =-15V,I _D =-6.5A	-	21.3	-	nC
Gate-Source Charge	Q _{gs}		-	2.2	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	4.5	-	nC
Drain-Source Diode Characteristics	- 1		ı	ı		ı
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6.5A	-	-	-1.2	V
				1		

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- $\textbf{4.} \ \textbf{Guaranteed by design}, \ \textbf{not subject to production}$



N- Channel Typical Electrical and Thermal Characteristics (Curves)

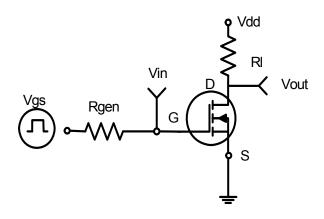


Figure 1:Switching Test Circuit

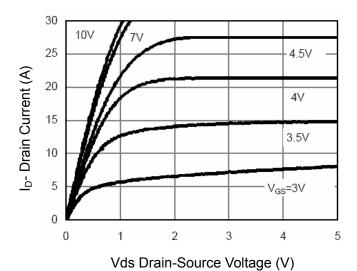


Figure 3 Output Characteristics

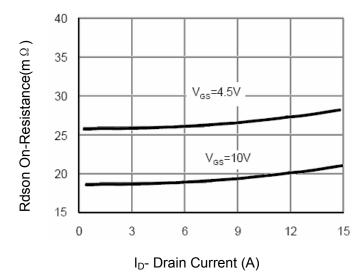


Figure 5 Drain-Source On-Resistance

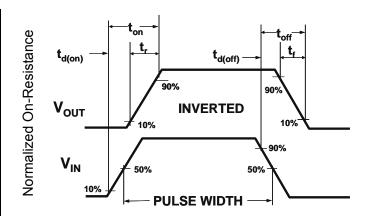


Figure 2:Switching Waveforms

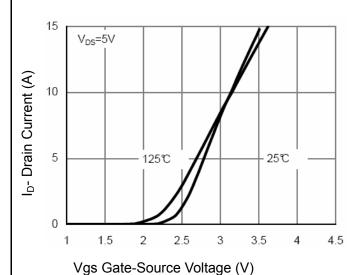


Figure 4 Transfer Characteristics

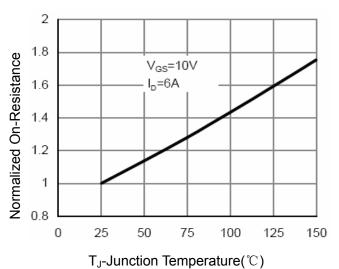


Figure 6 Drain-Source On-Resistance



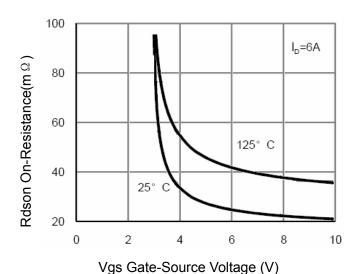
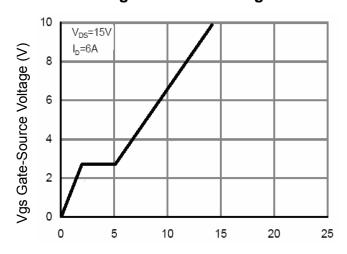
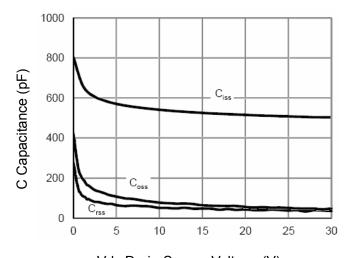


Figure 7 Rdson vs Vgs

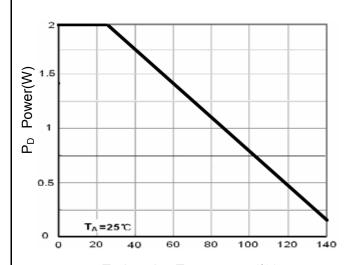


Qg Gate Charge (nC) Figure 9 Gate Charge



Vds Drain-Source Voltage (V)

Figure 11 Capacitance vs Vds



 T_J -Junction Temperature($^{\circ}$ C) Figure 8 Power Dissipation

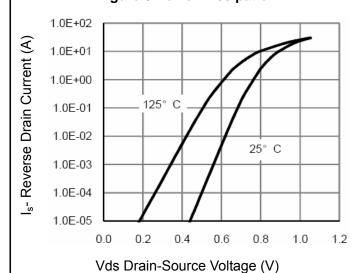
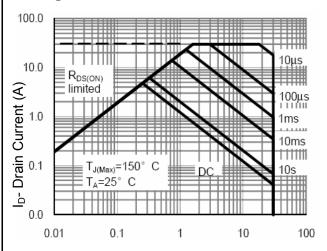


Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)
Figure 12 Safe Operation Area



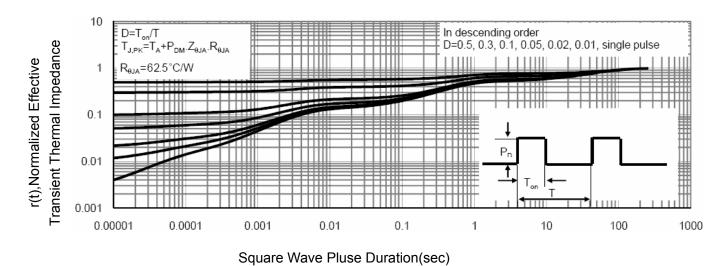


Figure 13 Normalized Maximum Transient Thermal Impedance



P- Channel Typical Electrical and Thermal Characteristics (Curves)

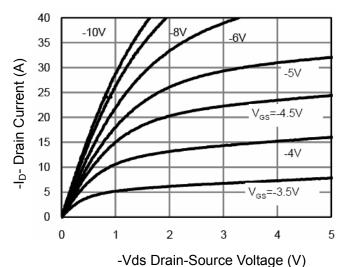
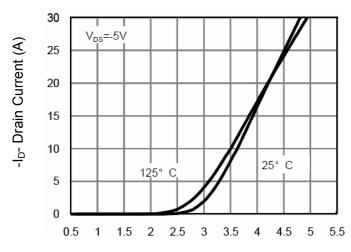


Figure 1 Output Characteristics



-Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics

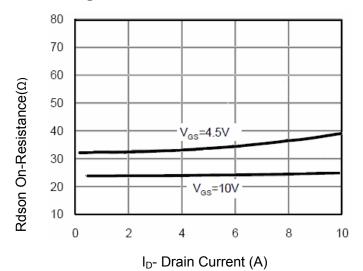


Figure 3 Rdson- Drain Current

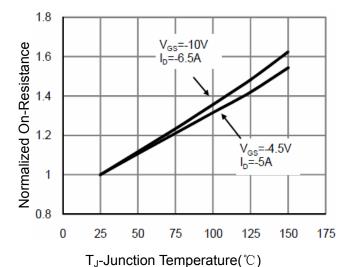


Figure 4 Rdson-Junction Temperature

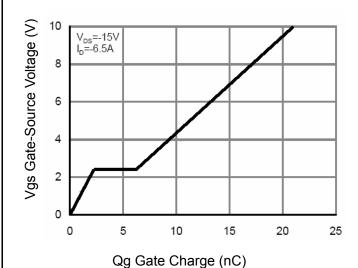


Figure 5 Gate Charge

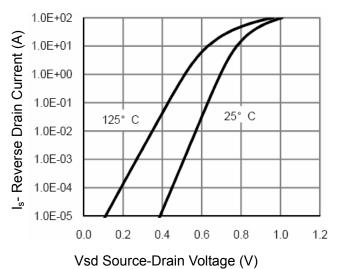
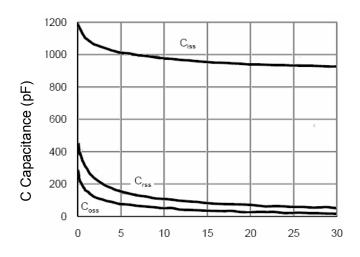
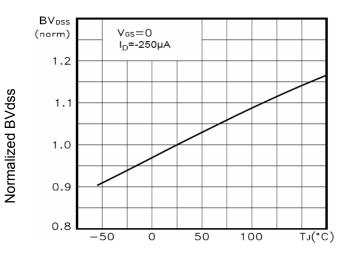


Figure 6 Source- Drain Diode Forward





Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds



 T_J -Junction Temperature (°C) Figure 9 BV_{DSS} vs Junction Temperature

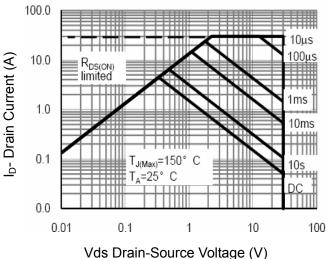


Figure 8 Safe Operation Area

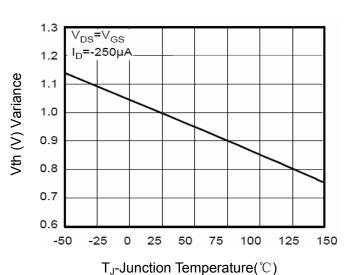
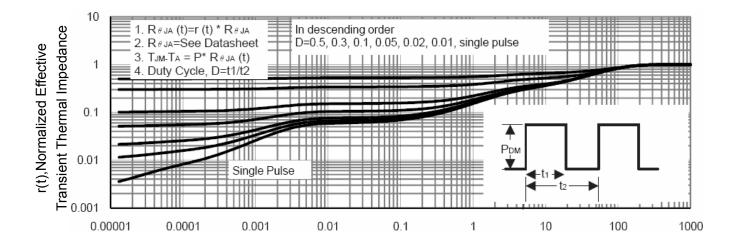


Figure 10 V_{GS(th)} vs Junction Temperature

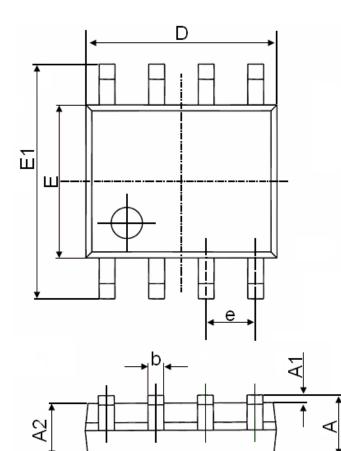


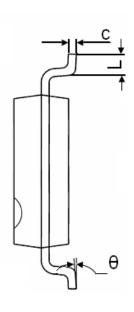
Square Wave Pluse Duration(sec)

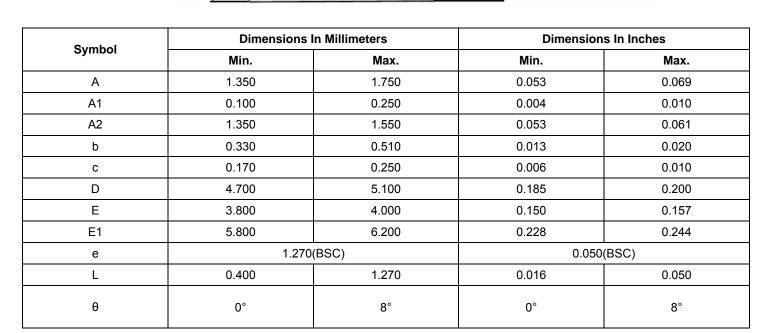
Figure 11 Normalized Maximum Transient Thermal Impedance



SOP-8 Package Information









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